MW4IC2020MBR1

MW4IC2020GMBR1

1805-1990 MHz, 20 W, 26 V

GSM/GSM EDGE, CDMA

**RF LDMOS WIDEBAND** 

INTEGRATED POWER AMPLIFIERS

CASE 1329-09

TO-272 WB-16

PLASTIC

MW4IC2020MBR1

CASE 1329A-03

TO-272 WB-16 GULL

PLASTIC

MW4IC2020GMBR1

# The Wideband IC Line **RF LDMOS Wideband Integrated Power Amplifiers**

The MW4IC2020M wideband integrated circuit is designed for base station applications. It uses Motorola's newest High Voltage (26 to 28 Volts) LDMOS IC technology and integrates a multi-stage structure. Its wideband On-Chip design makes it usable from 1600 to 2400 MHz. The linearity performances cover all modulations for cellular applications: GSM, GSM EDGE, TDMA, CDMA and W-CDMA.

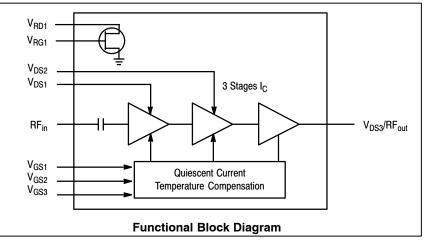
#### **Final Application**

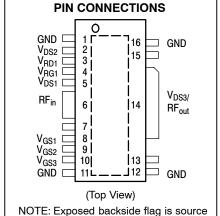
Typical Two-Tone Performance: V<sub>DD</sub> = 26 Volts, I<sub>DQ1</sub> = 80 mA, I<sub>DQ2</sub> = 200 mA, I<sub>DQ3</sub> = 300 mA, P<sub>out</sub> = 20 Watts PEP, Full Frequency Band Power Gain — 29 dB IMD — -32 dBc Drain Efficiency — 26% (at 1805 MHz) and 20% (at 1990 MHz) **Driver Applications** Typical GSM EDGE Performance: V<sub>DD</sub> = 26 Volts, I<sub>DQ1</sub> = 80 mA, I<sub>DQ2</sub> = 230 mA, I<sub>DQ3</sub> = 230 mA, P<sub>out</sub> = 5 Watts Avg., Full Frequency Band Power Gain — 29 dB Spectral Regrowth @ 400 kHz Offset = -66 dBc Spectral Regrowth @ 600 kHz Offset = -77 dBc

 $\begin{array}{l} \text{EVM} - 1\% \text{ rms} \\ \text{Typical CDMA Performance: } V_{\text{DD}} = 26 \text{ Volts, } I_{\text{DQ1}} = 80 \text{ mA, } I_{\text{DQ2}} = \\ 240 \text{ mA, } I_{\text{DQ3}} = 250 \text{ mA, } P_{\text{out}} = 1 \text{ Watt Avg., Full Frequency Band, IS-97} \\ \text{Pilot, Sync, Paging, Traffic Codes 8 through 13} \\ \text{Power Gain} - 30 \text{ dB} \\ \text{ACPR @ 885 kHz Offset} = -61 \text{ dBc @ 30 kHz Bandwidth} \\ \end{array}$ 

ALT1 @ 1.25 MHz Offset = -69 dBc @ 12.5 kHz Bandwidth ALT2 @ 2.25 MHz Offset = -59 dBc @ 1 MHz Bandwidth

- Capable of Handling 3:1 VSWR, @ 26 Vdc, 1990 MHz, 8 Watts CW Output Power
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- On-Chip Matching (50 Ohm Input, DC Blocked, >5 Ohm Output)
- Integrated Temperature Compensation with Enable/Disable Function
- On-Chip Current Mirror g<sub>m</sub> Reference FET for Self Biasing Application (1)
- Integrated ESD Protection
- Also Available in Gull Wing for Surface Mount
- In Tape and Reel. R1 Suffix = 500 Units per 44 mm, 13 inch Reel





terminal for transistors.

(1) Refer to AN1987/D, Quiescent Current Control for the RF Integrated Circuit Device Family. Go to http://www.motorola.com/semiconductors/rf. Select Documentation/Application Notes - AN1987.





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**REV 4** 

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	Vdc
Gate - Source Voltage	V <sub>GS</sub>	-0.5, +15	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	175	°C
Input Power	P <sub>in</sub>	20	dBm

#### **THERMAL CHARACTERISTICS**

Characteristic	Symbol	Value (1)	Unit
Thermal Resistance, Junction to Case	R <sub>0JC</sub>		°C/W
Stage 1		10.5	
Stage 2		5.1	
Stage 3		2.3	

#### **ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)
Charge Device Model	C5 (Minimum)

#### MOISTURE SENSITIVITY LEVEL

Test Methodology	Rating
Per JESD 22-A113	3

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
FUNCTIONAL TESTS (In Motorola Wideband 1805-1990 MHz Test Fixture $I_{DQ3}$ = 300 mA, P <sub>out</sub> = 20 W PEP, f1 = 1990 MHz, f2 = 1990.1 MHz and f1 =		, 55			= 200 mA,
Power Gain	G <sub>ps</sub>	27	29	—	dB
Drain Efficiency f1 = 1805 MHz, f2 = 1805.1 MHz f1 = 1990 MHz, f2 = 1990.1 MHz	η <sub>D</sub>	24 18	26 20	_	%
Input Return Loss	IRL	—	—	-10	dB
Intermodulation Distortion	IMD	_	-32	-27	dBc
Stability (100 mW <p<sub>out&lt;8 W CW, Load VSWR = 3:1, All Phase Angles)</p<sub>		No Spurious > -60 dBc			
TYPICAL PERFORMANCES (In Motorola Test Fixture, 50 ohm system) V <sub>C</sub> 1805 MHz <frequency<1990 1-tone<="" mhz,="" td=""><td><sub>D</sub> = 26 Vdc, I<sub>[</sub></td><td><sub>DQ1</sub> = 80 mA,</td><td>I<sub>DQ2</sub> = 200 n</td><td>nA, I<sub>DQ3</sub> = 30</td><td>0 mA,</td></frequency<1990>	<sub>D</sub> = 26 Vdc, I <sub>[</sub>	<sub>DQ1</sub> = 80 mA,	I <sub>DQ2</sub> = 200 n	nA, I <sub>DQ3</sub> = 30	0 mA,
Saturated Pulsed Output Power (f = 1 kHz, Duty Cycle 10%)	P <sub>sat</sub>	_	33	_	Watts
Quiescent Current Accuracy over Temperature (-10 to 85°C)	$\Delta I_{QT}$	—	±5	_	%
Gain Flatness in 30 MHz Bandwidth @ P <sub>out</sub> = 1 W CW	G <sub>F</sub>	—	0.15	—	dB
Deviation from Linear Phase in 30 MHz Bandwidth @ P <sub>out</sub> = 1 W CW 1805-1880 MHz	Φ	_	±0.5	_	o

Delay @ Pout = 1 W CW Including Output Matching Delay 1.8 ns 0 Part to Part Phase Variation @ Pout = 1 W CW ΦΔ ±10 (1) MTTF calculator available at http://www.motorola.com/semiconductors/rf. Select Tools/Software/Application Software/Calculators to

1930-1990 MHz

access the MTTF calculators by product.

(continued)

±0.2

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#### **ELECTRICAL CHARACTERISTICS** — continued ( $T_C = 25^{\circ}C$ unless otherwise noted)

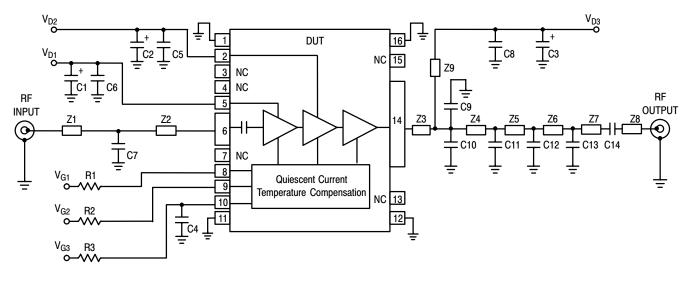
Characteristic	Symbol	Min	Тур	Мах	Unit

**TYPICAL CDMA PERFORMANCES** (In Modified CDMA Test Fixture, 50 ohm system) V<sub>DD</sub> = 26 Vdc, <sub>DQ1</sub> = 80 mA, I<sub>DQ2</sub> = 240 mA, I<sub>DQ3</sub> = 250 mA, P<sub>out</sub> = 1 W Avg., I1930 MHz<Frequency<1990 MHz, 1-Tone, 9 Channel Forward Model (Pilot, Paging, Sync, Traffic Codes 8 through 13). Peak/Avg. Ratio 9.8 dB @ 0.01% Probability on CCDF.

Power Gain	G <sub>ps</sub>	—	30	—	dB
Drain Efficiency	η <sub>D</sub>	—	5	—	%
Adjacent Channel Power Ratio (±885 kHz @ 30 kHz Bandwidth)	ACPR	—	-61	—	dBc
Alternate 1 Channel Power Ratio (±1.25 MHz @ 12.5 kHz Bandwidth)	ALT1	—	- 69	—	dBc
Alternate 2 Channel Power Ratio (±2.25 MHz @ 1 MHz Bandwidth)	ALT2		-59		dBc

**TYPICAL GSM EDGE PERFORMANCES** (In Modified GSM EDGE Test Fixture, 50 ohm system)  $V_{DD} = 26$  Vdc,  $I_{DQ1} = 80$  mA,  $I_{DQ2} = 230$  mA,  $I_{DQ3} = 230$  mA,  $P_{out} = 5$  W Avg., 1805 MHz<Frequency<1990 MHz

Power Gain	G <sub>ps</sub>	—	29	—	dB
Drain Efficiency	η <sub>D</sub>	—	15	—	%
Error Vector Magnitude	EVM	—	1	—	% rms
Spectral Regrowth at 400 kHz Offset	SR1	—	-66	—	dBc
Spectral Regrowth at 600 kHz Offset	SR2	—	-77	—	dBc



Z1	1.820" x 0.087" Microstrip	Z6	0.303" x 0.087" Microstrip
Z2	0.245" x 0.087" Microstrip	Z7	0.640" x 0.087" Microstrip
Z3	0.345" x 0.236" Microstrip	Z8	0.334" x 0.087" Microstrip
Z4	0.327" x 0.087" Microstrip	Z9	1.231" x 0.043" Microstrip
Z5	0.271" x 0.087" Microstrip	PCB	Taconic TLX8-0300, 0.030", $\epsilon_r = 2.55$

#### Figure 1. MW4IC2020MBR1(GMBR1) Test Circuit Schematic

Table 1. MW4IC2020MBR1(GMBR1)	Test Circuit Com	ponent Designations and Values
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Part	Description	Part Number	Manufacturer
C1, C2, C3	10 µF, 35 V Tantalum Capacitors	TAJE226M035	AVX
C4	220 nF Chip Capacitor (1206)	12065C224K28	AVX
C5, C6, C8	6.8 pF 100B Chip Capacitors	100B6R8CW	ATC
C7	0.5 pF 100B Chip Capacitor	100B0R5BW	ATC
C9, C11	1.8 pF 100B Chip Capacitors	100B1R8BW	ATC
C10	2.2 pF 100B Chip Capacitor	100B2R2BW	ATC
C12	1 pF 100B Chip Capacitor	100B1R0BW	ATC
C13	0.3 pF 100B Chip Capacitor	100B0R3BW	ATC
C14	10 pF 100B Chip Capacitor	100B100GW	ATC
R1, R2, R3	1.8 k $\Omega$ Chip Resistors (1206)		

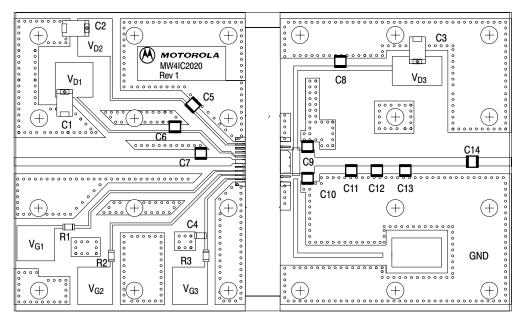
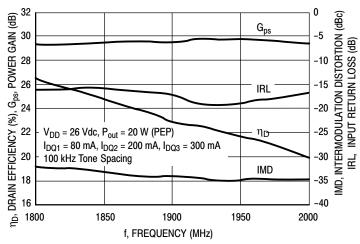
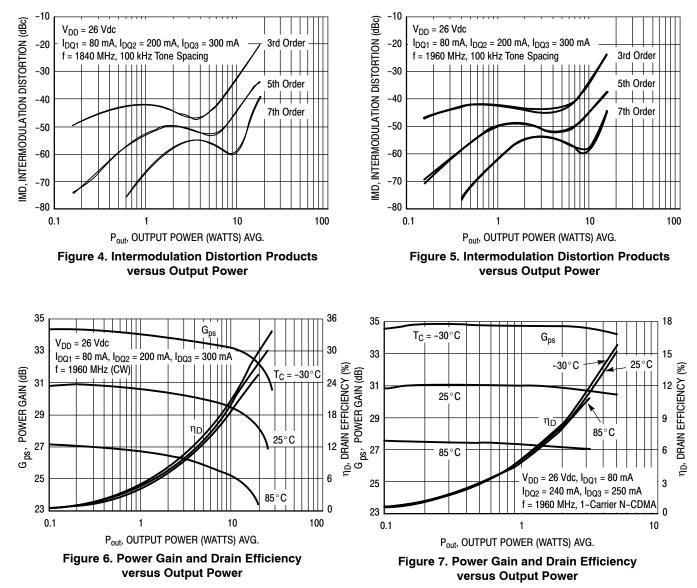


Figure 2. MW4IC2020MBR1(GMBR1) Test Circuit Component Layout

**TYPICAL CHARACTERISTICS** 



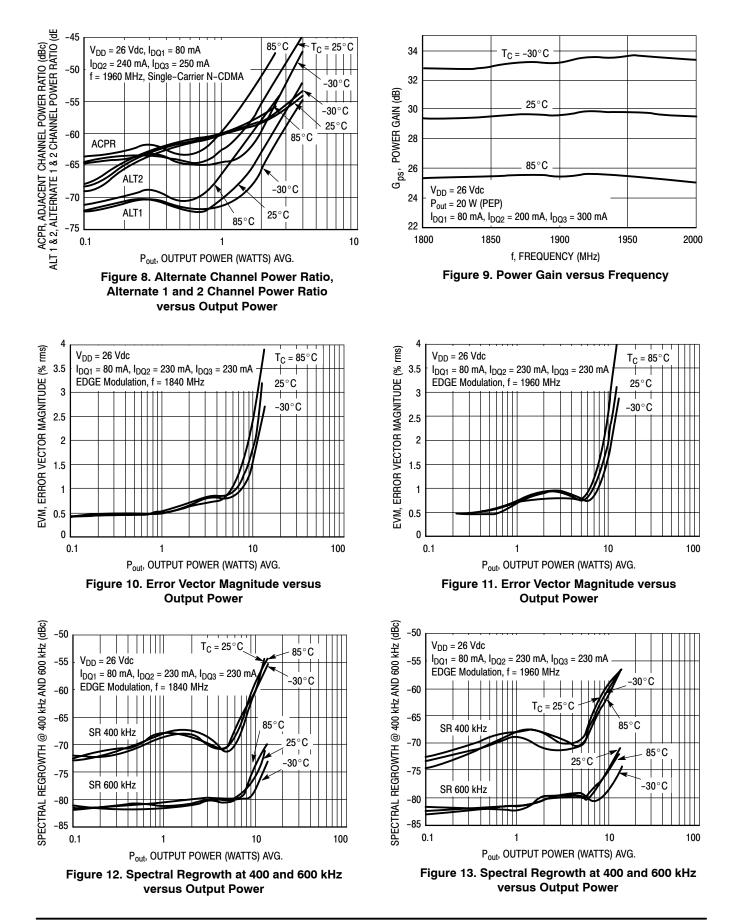




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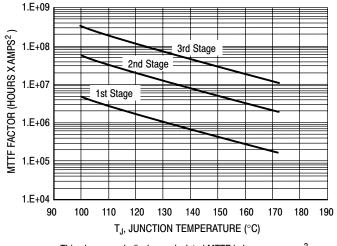
MOTOROLA RF DEVICE DATA

**TYPICAL CHARACTERISTICS** 



For More Information On This Product, MW4IC2020MBR1 MW4IC2020GMBR1 Contaction On This Product,

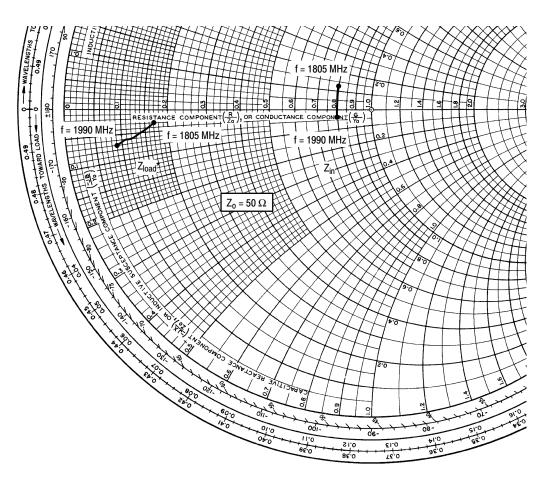
**TYPICAL CHARACTERISTICS** 



This above graph displays calculated MTTF in hours x ampere<sup>2</sup> drain current. Life tests at elevated temperatures have correlated to better than  $\pm 10\%$  of the theoretical prediction for metal failure. Divide MTTF factor by  $I_D{}^2$  for MTTF in a particular application.







 $V_{DD}$  = 26 V,  $I_{DQ1}$  = 80 mA,  $I_{DQ2}$  = 200 mA,  $I_{DQ1}$  = 300 mA,  $P_{out}$  = 20 W PEP Two-Tone CW

f MHz	Z <sub>in</sub> Ω	Z <sub>load</sub> Ω
1805	40.00 + j6.50	8.75 - j1.42
1842	40.00 + j2.00	7.00 - j2.70
1880	40.00 - j1.50	5.90 - j2.97
1930	40.00 - j1.80	5.46 - j3.20
1960	40.00 - j2.10	4.30 - j3.35
1990	40.00 - j2.60	4.45 - j3.30

Zin Device input impedance as measured from = gate to ground.

Test circuit impedance as measured Zload = from drain to ground.

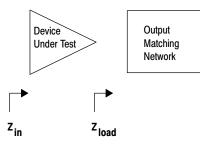
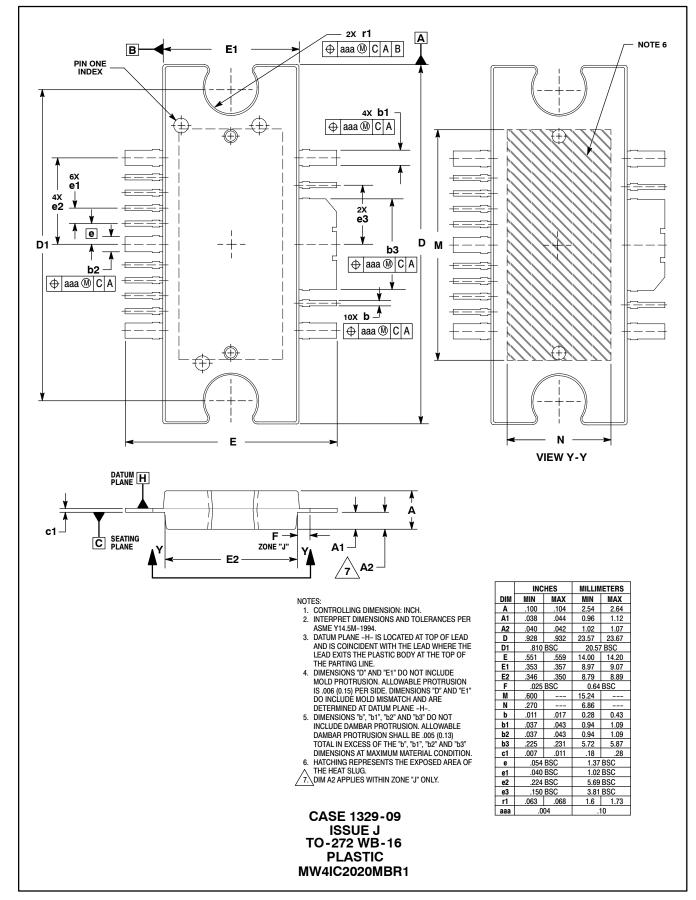
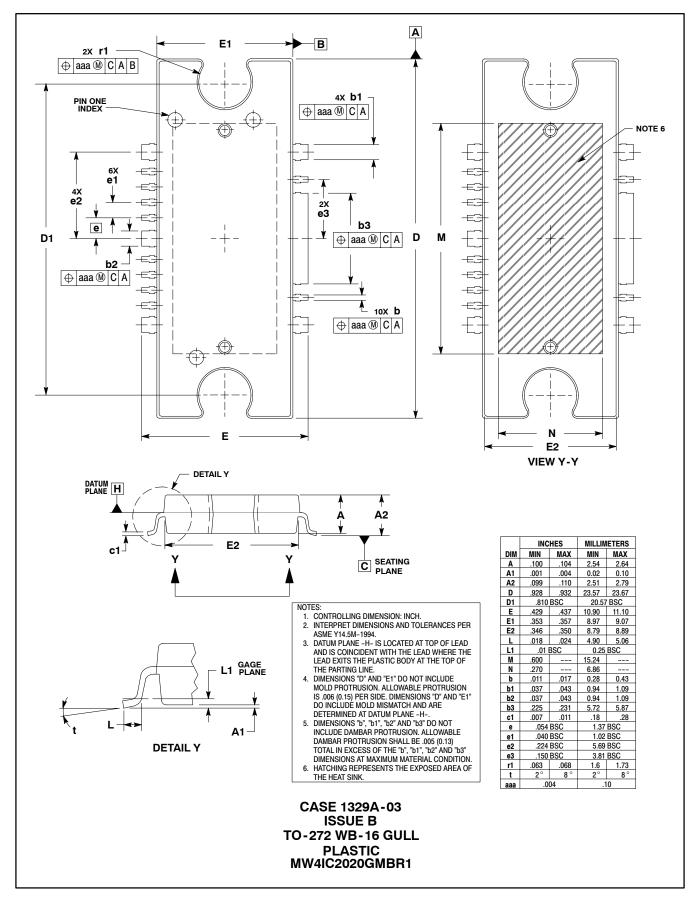


Figure 15. Series Equivalent Output Impedance

PACKAGE DIMENSIONS



MW4IC2020MBR1 MW4IC2020GMBR1 For More Information On This Product, MOTOROLA RF DEVICE DATA Go to: www.freescale.com



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